503510697 10/06/2015

EPAS ID: PAT3557323

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 Stylesheet Version v1.2

SUBMISSION TYPE: NEW ASSIGNMENT NATURE OF CONVEYANCE: ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
NAOYA SAIKI	11/14/2007
ISAO ICHIKAWA	11/14/2007
HIRONORI SHIZUHATA	11/14/2007
OSAMU YAMAZAKI	11/14/2007

RECEIVING PARTY DATA

Name:	LINTEC CORPORATION		
Street Address: 23-23, HONCHO, ITABASHI-KU			
City:	TOKYO		
State/Country:	JAPAN		
Postal Code:	1730001		

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	14868421

CORRESPONDENCE DATA

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Address Line 4: PITTSBURGH, PENNSYLVANIA 15222

ATTORNEY DOCKET NUMBER:	1217-155882
NAME OF SUBMITTER:	KENT E. BALDAUF
SIGNATURE:	/Kent E. Baldauf, Sr./
DATE SIGNED:	10/06/2015

Total Attachments: 3

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> **PATENT REEL: 036734 FRAME: 0408** 503510697

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PATENT REEL: 036734 FRAME: 0409 Form **PTO-1595** (Rev. 03/11) OMB No. 0651-0027 (exp. 4/30/2015)

RECORDATION FORM COVER SHEET		
PATENTS ONLY		
To the Director of the U.S. Patent and Trademark Office: Pleas	e record the attached documents or the new address(es) below.	
1. Name of conveying party(ies) Naoya Saiki Isao Ichikawa Hironori Shizuhata Osamu Yamazaki Additional name(s) of conveying party(ies) attached? Yes ✓ No 3. Nature of conveyance/Execution Date(s): Execution Date(s) November 14, 2007 ✓ Assignment Merger Security Agreement Change of Name Joint Research Agreement Government Interest Assignment Executive Order 9424, Confirmatory License Other 4. Application or patent number(s): This execution of the said of the s	2. Name and address of receiving party(ies) Name: Lintec Corporation Internal Address: 23-23, Honcho, Itabashi-ku Street Address: City: Tokyo State: Country: JP Zip: 1730001 Additional name(s) & address(es) attached? Yes Voodocument is being filed together with a new application.	
A. Patent Application No.(s) 14/868,421 Additional numbers att	B. Patent No.(s) ached? Yes V No	
5. Name and address to whom correspondence concerning document should be mailed:	6. Total number of applications and patents involved: 1	
Name: Kent E. Baldauf, Sr.	7. Total fee (37 CFR 1.21(h) & 3.41) \$	
Internal Address: The Webb Law Firm	Authorized to be charged by credit card Authorized to be charged to deposit account	
Street Address: One Gateway Center	Enclosed	
420 Ft. Duquesne Blvd., Ste 1200	None required (government interest not affecting title)	
City: Pittsburgh	8. Payment Information	
State: <u>PA</u> Zip: <u>15222</u>	a. Credit Card Last 4 Numbers 1916 Expiration Date 05/2018	
Phone Number: 412-471-8815	b. Deposit Account Number 23-0650	
Fax Number: 412-945-5933		
Email Address: assignments@webblaw.com	Authorized User Name	
9. Signature: Kanf & Bald Signature	October 6, 2015 Date	
Kent E. Baldauf, Sr. Reg No. 25,826	Total and a second seco	
Name of Person Signing	sheet, attachments, and documents:	

Documents to be recorded (including cover sheet) should be faxed to (571) 273-0140, or mailed to:
Mail Stop Assignment Recordation Services, Director of the USPTO, P.O.Box 1450, Alexandria, V.A. 22313-1450

Doc. No. 1217-155882

Assignment of Application



WHEREAS, I (WE) 1) Naoya SAIKI, 2) Isao ICHIKAWA, 3) Hironori SHIZUHATA and 4) Osamu YAMAZAKI, 1), 2), 3) and 4) of c/o LINTEC CORPORATION, 23-23, Honcho, Itabashi-ku, Tokyo 1730001 Japan, respectively,

have invented certain new and useful improvements in: "ADHESIVE COMPOSITION, ADHESIVE SHEET AND PRODUCTION PROCESS FOR SEMICONDUCTOR DEVICE"

ERT TITLE OF ENTION:

(Application No.	**************************************	filed),	and
WHEREAS.	LINTEC CORPORATION	N		

ert names) address of upany or ter assignee

(hereinafter referred to as "ASSIGNEE") having a place of business at : 23-23, Honcho, Itabashi-ku, Tokyo 1730001 Japan is desirous of acquiring the entire right, title and interest in and to said invention and in and to any Letters Patent that may be granted therefore in the United States and its territorial possessions and in any and all foreign countries;

NOW, THEREFORE, in consideration of the sum of FIVE DOLLARS (\$5.00), the receipt whereof is hereby acknowledged, and for other good and valuable consideration, I(WE), by these presents do sell, assign and transfer unto said ASSIGNEE, the full and exclusive right to the said invention in the United States and its territorial possessions and in all foreign countries and the entire right, title and interest in and to any and all Letters Patent which may be granted therefor in the United States and its territorial possessions and in any and all foreign countries and in and to any and all divisions, reissues, continuations, substitutions and renewals thereof.

I (WE) hereby authorize and request the Patent Office Officials in the United States and its territorial possessions and any and all foreign countries to issue any and all of said Letters Patent, when granted, to said ASSIGNEE as the assignee of my (our) entire right, title and interest in and to the same, for the sole use and behoof of said ASSIGNEE, its (his) successors and assigns, to the full end of the term for which said Letters Patent may be granted, as fully and entirely as the same would have been held by me (us) had this Assignment and sale not been made.

PATENT REEL: 036734 FRAME: 0411 Further, I (WE) agree that I (WE) will communicate to said ASSIGNEE or its (his) representatives any facts known to me (us) respecting said invention, and testify in any legal proceeding, sign all lawful papers, execute all divisional, continuation, substitute, renewal and reissue applications, execute all necessary assignment papers to cause any and all of said Letter Patent to be issued to said ASSIGNEE, make all rightful oaths, and, generally do everything possible to aid said ASSIGNMEE, its (his) successors and assigns, to obtain and enforce proper protection for said invention in the United States and its territorial possessions and in any and all foreign countries.

The undersigned hereby grant(s) the firm of THE WEBB LAW FIRM of 700 Koppers Building 436 Seventh Avenue Pittsburgh PA 15219-1818 United States the power to insert on this assignment any further identification, including the application number and filing date, which may be necessary or desirable in order to comply with the rules of the United States Patent and Trademark Office for recordation of this document.

M

Date: _	November 14, 2007	Marya Saidi
		(Signeture of Inverse) Naoya SAIKI
Date:	November 14, 2007	Isso Ichihawa
		(Signature of Inventor) ISAO ICHIKAWA
Date:	November 14, 2007	Hironori Shignhata (Signature of Inventor) Hironori SHIZUHATA
Date: _	November 14, 2007	Osamu Yamezaki (Signature of Inventor) Osamu YAMAZAKI
		OSCHIC FERMINENT
Date: _		(Signature of Inventor)
Date: _		(Signature of Inventor)
Data:		
Dave-		(Signature of Inventor)
Date:		
		(Signature of Inventor)
Date:		
*****		(Signature of Inventor)
Date:		
•		(Signature of Inventor)

PATENT REEL: 036734 FRAME: 0412

RECORDED: 10/06/2015